COMPLIANT

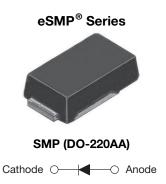
HALOGEN

FREE



## Vishay General Semiconductor

# Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



#### **LINKS TO ADDITIONAL RESOURCES**



| PRIMARY CHARACTERISTICS                  |                |  |  |
|--|----------------|--|--|
| I <sub>F(AV)</sub>                       | 2.0 A          |  |  |
| V <sub>RRM</sub>                         | 60 V           |  |  |
| I <sub>FSM</sub>                         | 50 A           |  |  |
| V <sub>F</sub> at I <sub>F</sub> = 2.0 A | 0.46 V         |  |  |
| T <sub>J</sub> max.                      | 150 °C         |  |  |
| Package                                  | SMP (DO-220AA) |  |  |
| Circuit configuration                    | Single         |  |  |

#### **FEATURES**

- · Low profile package
- Trench MOS Schottky technology
- · Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **TYPICAL APPLICATIONS**

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

#### **MECHANICAL DATA**

Case: SMP (DO-220AA)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and

commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

| MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)                    |                               |             |      |  |
|--|-------------------------------|-------------|------|--|
| PARAMETER  | SYMBOL                        | V2PL63L     | UNIT |  |
| Device marking code  |                               | 2LF         |      |  |
| Maximum repetitive peak reverse voltage  | V <sub>RRM</sub>              | 60          | V    |  |
| Maximum DC forward current   | I <sub>F</sub> <sup>(1)</sup> | 2           | A    |  |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | I <sub>FSM</sub>              | 50          | А    |  |
| Operating junction temperature range   | T <sub>J</sub> <sup>(2)</sup> | -40 to +150 | °C   |  |
| Storage temperature range  | T <sub>STG</sub>              | -55 to +150 | °C   |  |

#### Notes

<sup>(1)</sup> Free air, mounted on recommended copper pad area

 $<sup>^{(2)}</sup>$  The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ 



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| <b>ELECTRICAL CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise noted) |                       |   |  |      |      |      |
|---|-----------------------|---|--|------|------|------|
| PARAMETER   | TEST CO               | TEST CONDITIONS   |  | TYP. | MAX. | UNIT |
| Instantaneous forward voltage   | I <sub>F</sub> = 1 A  | T 05 %  | $T_{J} = 25  ^{\circ}\text{C}$ $V_{F}  ^{(1)}$ $V_{F}  ^{(1)}$ | 0.45 | -    | V    |
|   | I <sub>F</sub> = 2 A  | 1j=25 C   |  | 0.51 | 0.58 |      |
|   | I <sub>F</sub> = 1 A  | T <sub>J</sub> = 125 °C   |  | 0.36 | -    |      |
|   | I <sub>F</sub> = 2 A  |   |  | 0.46 | 0.52 |      |
| Reverse current   | V 60.V                | $V_R = 60 \text{ V}$ $T_J = 25 \text{ °C}$ $T_J = 125 \text{ °C}$ | I <sub>R</sub> <sup>(2)</sup>                                  | -    | 0.05 | - mA |
|   | v <sub>R</sub> = 60 v |   |  | 1.8  | 4    |      |
| Typical junction capacitance  | 4.0 V, 1 MH           | 4.0 V, 1 MHz  |  | 360  | -    | pF   |

#### **Notes**

 $^{(1)}$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 5 ms

| THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise specified) |                          |     |      |  |
|---|--------------------------|-----|------|--|
| PARAMETER   | SYMBOL V2PL63L U         |     |      |  |
| Typical thermal resistance  | R <sub>0</sub> JA (1)(2) | 125 | °C/W |  |
|   | R <sub>0JM</sub> (3)     | 15  | C/VV |  |

#### **Notes**

- $^{(1)}$  Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  junction-to-ambient
- $^{(2)}$  The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$
- (3) Mounted on 10 mm x 10 mm copper pad area PCB; thermal resistance R<sub>0JM</sub> junction-to-mount

| ORDERING INFORMATION (Example) |                 |                        |               |                                    |  |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|--|
| PREFERRED P/N                  | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |  |
| V2PL63L-M3/H                   | 0.024           | Н                      | 3000          | 7" diameter plastic tape and reel  |  |
| V2PL63L-M3/I                   | 0.024           | I                      | 10 000        | 13" diameter plastic tape and reel |  |
| V2PL63LHM3/H (1)               | 0.024           | Н                      | 3000          | 7" diameter plastic tape and reel  |  |
| V2PL63LHM3/I (1)               | 0.024           | I                      | 10 000        | 13" diameter plastic tape and reel |  |

#### Note

(1) AEC-Q101 qualified



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### RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

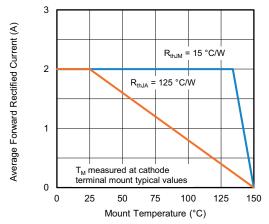


Fig. 1 - Maximum Forward Current Derating Curve

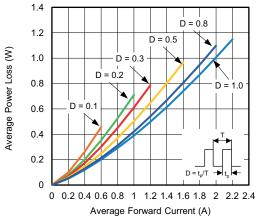


Fig. 2 - Forward Power Loss Characteristics

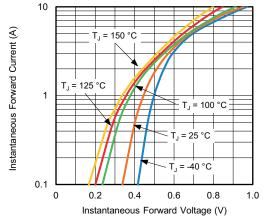


Fig. 3 - Typical Instantaneous Forward Characteristics

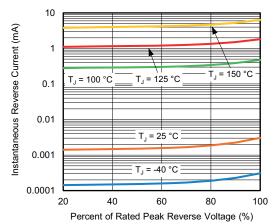


Fig. 4 - Typical Reverse Characteristics

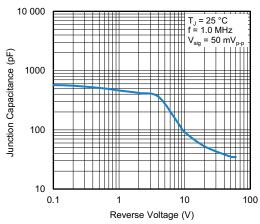


Fig. 5 - Typical Junction Capacitance

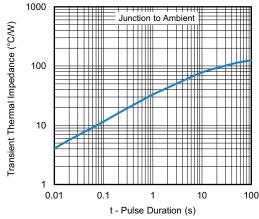


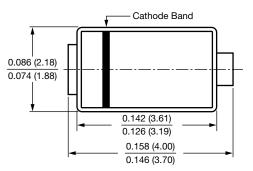
Fig. 6 - Typical Transient Thermal Impedance

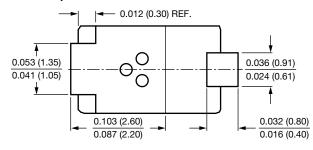


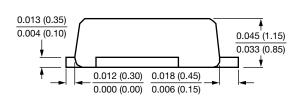
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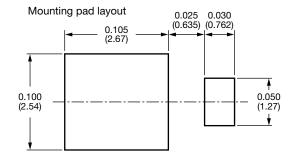
### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

### **SMP (DO-220AA)**











## **Legal Disclaimer Notice**

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